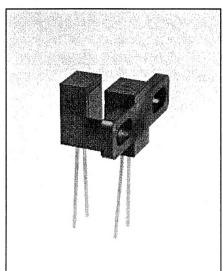


Slotted Optical Switches Types OPB830L, OPB840L Series



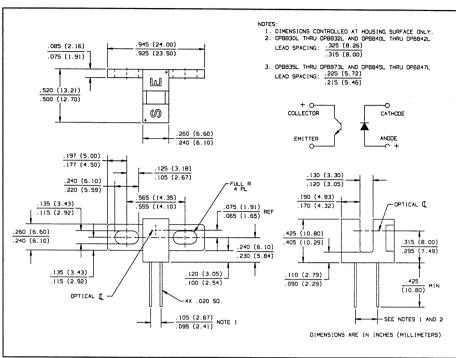
Features

- 0.125" (3.18 mm) wide slot
- · Choice of aperture
- Choice of opaque or IR transmissive shell material
- Side mounting configuration
- Choice of lead spacing

Description

This series of slotted switches provides the design engineer with the flexibility of a custom device from a standard product line. Building from a standard housing with a .125" (3.18 mm) wide slot, the user can specify (1) electrical output parameters, (2) choice of lead spacing, (3) discrete shell material and (4) aperture width.

All housings are an opaque grade of injection-molded plastic to minimize the assembly's sensitivity to ambient radiation, both visible and near-infrared. Discrete shells (exposed only on the parallel faces inside the device throat) are either IR transmissive plastic for applications where aperture contamination may occur or opaque plastic with aperture openings for maximum protection against ambient light.



Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage and Operating Temperature Range40 $^{\circ}$ C to +85 $^{\circ}$ C ⁽¹⁾ Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 sec. with soldering iron] 240 $^{\circ}$ C ⁽²⁾ Input Diode
Forward DC Current
Peak Forward Current (1 µs pulse width, 300 pps)
Reverse DC Voltage
Power Dissipation
Output Phototransistor
Collector-Emitter Voltage
Emitter-Collector Voltage
Collector DC Current
Power Dissipation

- (1) Derate linearly 1.67 mW/° C above 25° C.
- (2) RMA flux is recommended. Duration can be extended to 10 sec. max. when flow soldering.
- (3) All parameters tested using pulse technique.
- (4) Lead spacing is .220" or .320". Leads are 0.20" sq and .425" long (min).
- (5) Methanol or isopropanol are recommended cleaning agents. Plastic housing may be soluble in chlorinated hydrocarbons and ketones.

Notes:

Types OPB830L, OPB840L Series

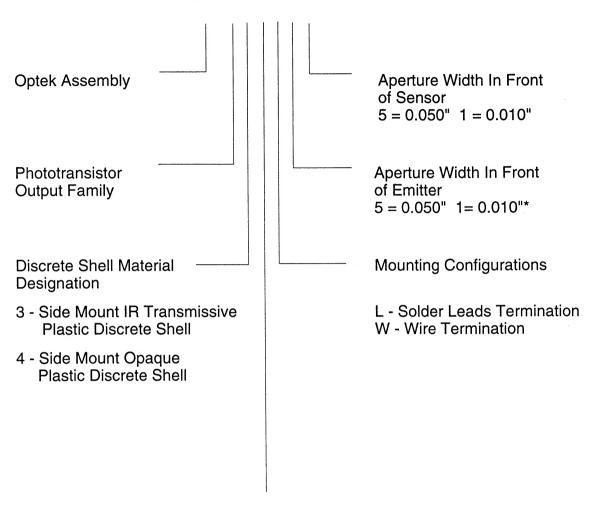
Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER		MIN	MAX	UNITS	TEST CONDITIONS
Input Diod	le				,	
VF	Forward Voltage			1.7	V	I _F = 20 mA
IR	Reverse Current			100	μΑ	V _R = 2 V
Output Ph	ototransistor			,	,	
V _{(BR)ECO}	Collector-Emitter Breakdown Voltage		30		V	Ic = 1 mA
V _{(BR)ECO}	Emitter-Collector Breakdown Voltage		5.0		V	I _E = 100 mA
ICEO	Collector-Emitter Dark Current			100	nA	V _{CE} = 10 V
Coupled				7		T
VCE(SAT)	Saturation Voltage Parameter A	OPB830L/OPB840L OPB835L/OPB845L		0.4	V	$I_C = 400 \mu A$, $I_F = 20 mA$
	Parameter B	OPB831L/OPB841L OPB836L/OPB846L		0.4	V	$I_C = 800 \mu A, I_F = 10 mA$
	Parameter C	OPB832L/OPB842L OPB837L/OPB847L		0.6	V	I _C = 1800 μA, I _F = 20 mA
Ic(on)	On-State Collector Curre Parameter A	OPB830L/OPB840L OPB835L/OPB845L	500		μА	V _{CE} = 10 V, I _F = 20 mA
	Parameter B	OPB831L/OPB841L OPB836L/OPB846L	1000		μА	V _{CE} = 5 V, I _F = 10 mA
	Parameter C	OPB832L/OPB842L OPB837L/OPB847L	1800		μА	V _{CE} = 0.6 V, I _F = 20 mA



PART NUMBER GUIDE

OPB 8 X X X X X



Electrical Specification Variations

- 0 Electrical Parameter A, 0.320" Lead Spacing
- 1 Electrical Parameter B, 0.320" Lead Spacing
- 2 Electrical Parameter C, 0.320" Lead Spacing
- 5 Electrical Parameter A, 0.220" Lead Spacing
- 6 Electrical Parameter B, 0.220" Lead Spacing
- 7 Electrical Parameter C, 0.220" Lead Spacing

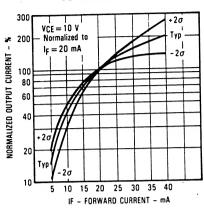
(972) 323-2200

^{*}Assemblies with dual 0.010" apertures are currently available with electrical parameter "A" only.

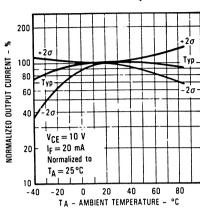
Types OPB830L, OPB840L Series

Typical Performance Curves

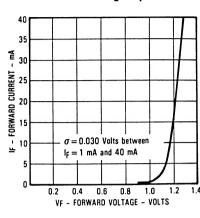




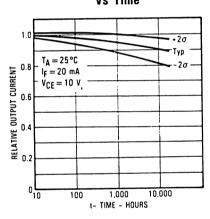
Normalized Output Current vs Ambient Temperature



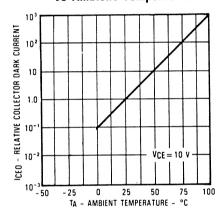
Forward Current vs Forward Voltage Input Diode



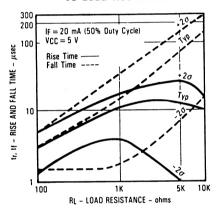
Relative Output Current vs Time



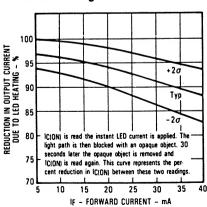
Collector Dark Current vs Ambient Temperature



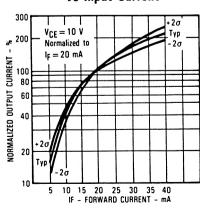
Rise and Fall Time vs Load Resistance



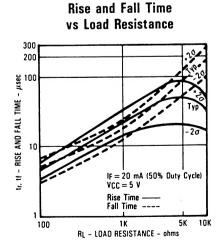
Reduction in Output Current Due to LED Heating vs Forward Current



Normalized Output Current vs Input Current



All Part Numbers Ending in "1"



Optek reserves the right to make changes at any time in order to improve design and to supply the best product possible.